

Docket No.: 061282-0055

**PATENT**

**Reply Under 37 CFR 1.116 - Expedited Procedure - Technology Center 2800**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

|   |   |                            |
|---|---|----------------------------|
| In re Application of  | : | Customer Number: 53080     |
|   | : |                            |
| Takeshi KOBAYASHI, et al.                                   | : | Confirmation Number: 4950  |
|   | : |                            |
| Application No.: 10/757,388                                 | : | Group Art Unit: 2893       |
|   | : |                            |
| Filed: January 15, 2004                                     | : | Examiner: Dilinh P. Nguyen |
|   | : |                            |
| For:  | : |                            |
| LEAD FRAME, METHOD OF MANUFACTURING THE SAME, SEMICONDUCTOR | : |                            |
| DEVICE USING LEAD FRAME AND METHOD OF MANUFACTURING         | : |                            |
| SEMICONDUCTOR DEVICE  | : |                            |

**AMENDMENT UNDER 37 C.F.R. 1.116**

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the final Office Action dated June 16, 2009, having a three-month shortened statutory period for response set to expire on September 16, 2009, reconsideration of the above-identified application is respectfully requested in view of the following amendment and remarks.